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#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

2010.00	
Product Status	Active
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	31
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 10x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f101ffdfp-30

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

#### Table 1-1. List of Ordering Part Numbers

				(1/12)
Pin	Package	Data	Fields of	Ordering Part Number
count		flash	Application Note	
20 pins	20-pin plastic LSSOP	Mounted	А	R5F1006AASP#V0, R5F1006CASP#V0, R5F1006DASP#V0,
	(7.62 mm (300), 0.65			R5F1006EASP#V0
	mm pitch)			R5F1006AASP#X0, R5F1006CASP#X0, R5F1006DASP#X0,
				R5F1006EASP#X0
			D	R5F1006ADSP#V0, R5F1006CDSP#V0, R5F1006DDSP#V0,
				R5F1006EDSP#V0
				R5F1006ADSP#X0, R5F1006CDSP#X0, R5F1006DDSP#X0,
				R5F1006EDSP#X0
			G	R5F1006AGSP#V0, R5F1006CGSP#V0, R5F1006DGSP#V0,
				R5F1006EGSP#V0
				R5F1006AGSP#X0, R5F1006CGSP#X0, R5F1006DGSP#X0,
				R5F1006EGSP#X0
		Not	А	R5F1016AASP#V0, R5F1016CASP#V0, R5F1016DASP#V0,
		mounted		R5F1016EASP#V0
				R5F1016AASP#X0, R5F1016CASP#X0, R5F1016DASP#X0,
				R5F1016EASP#X0
			D	R5F1016ADSP#V0, R5F1016CDSP#V0, R5F1016DDSP#V0,
				R5F1016EDSP#V0
				R5F1016ADSP#X0, R5F1016CDSP#X0, R5F1016DDSP#X0,
				R5F1016EDSP#X0
24 pins	24-pin plastic	Mounted	А	R5F1007AANA#U0, R5F1007CANA#U0, R5F1007DANA#U0,
	HWQFN (4 $ imes$ 4mm,			R5F1007EANA#U0
	0.5 mm pitch)			R5F1007AANA#W0, R5F1007CANA#W0, R5F1007DANA#W0,
				R5F1007EANA#W0
			D	R5F1007ADNA#U0, R5F1007CDNA#U0, R5F1007DDNA#U0,
				R5F1007EDNA#U0
				R5F1007ADNA#W0, R5F1007CDNA#W0, R5F1007DDNA#W0,
				R5F1007EDNA#W0
			G	R5F1007AGNA#U0, R5F1007CGNA#U0, R5F1007DGNA#U0,
				R5F1007EGNA#U0
				R5F1007AGNA#W0, R5F1007CGNA#W0, R5F1007DGNA#W0,
				R5F1007EGNA#W0
		Not	А	R5F1017AANA#U0, R5F1017CANA#U0, R5F1017DANA#U0,
		mounted		R5F1017EANA#U0
				R5F1017AANA#W0, R5F1017CANA#W0, R5F1017DANA#W0,
				R5F1017EANA#W0
			D	R5F1017ADNA#U0, R5F1017CDNA#U0, R5F1017DDNA#U0,
				R5F1017EDNA#U0
				R5F1017ADNA#W0, R5F1017CDNA#W0, R5F1017DDNA#W0,
				R5F1017EDNA#W0

Note For the fields of application, refer to Figure 1-1 Part Number, Memory Size, and Package of RL78/G13.

Caution The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.



Table 1-1.	List of Ordering Part Numbers
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Pin count	Package	Data flash	Fields of Application	Ordering Part Number
			Note	
48 pins	48-pin plastic	Mounted	А	R5F100GAANA#U0, R5F100GCANA#U0, R5F100GDANA#U0,
	HWQFN (7 $\times$ 7 mm,			R5F100GEANA#U0, R5F100GFANA#U0, R5F100GGANA#U0,
	0.5 mm pitch)			R5F100GHANA#U0, R5F100GJANA#U0, R5F100GKANA#U0,
				R5F100GLANA#U0
				R5F100GAANA#W0, R5F100GCANA#W0, R5F100GDANA#W0, R5F100GEANA#W0,
				R5F100GFANA#W0, R5F100GGANA#W0,
				R5F100GHANA#W0, R5F100GJANA#W0,
				R5F100GKANA#W0, R5F100GLANA#W0
			D	R5F100GADNA#U0, R5F100GCDNA#U0, R5F100GDDNA#U0,
				R5F100GEDNA#U0, R5F100GFDNA#U0, R5F100GGDNA#U0,
				R5F100GHDNA#U0, R5F100GJDNA#U0, R5F100GKDNA#U0,
				R5F100GLDNA#U0
				R5F100GADNA#W0, R5F100GCDNA#W0,
				R5F100GDDNA#W0, R5F100GEDNA#W0,
				R5F100GFDNA#W0, R5F100GGDNA#W0,
				R5F100GHDNA#W0, R5F100GJDNA#W0,
				R5F100GKDNA#W0, R5F100GLDNA#W0
			G	R5F100GAGNA#U0, R5F100GCGNA#U0, R5F100GDGNA#U0
				R5F100GEGNA#U0, R5F100GFGNA#U0, R5F100GGGNA#U0 R5F100GHGNA#U0, R5F100GJGNA#U0
				R5F100GAGNA#W0, R5F100GCGNA#W0,
				R5F100GDGNA#W0, R5F100GEGNA#W0,
				R5F100GFGNA#W0, R5F100GGGNA#W0,
				R5F100GHGNA#W0, R5F100GJGNA#W0
		Not	А	R5F101GAANA#U0, R5F101GCANA#U0, R5F101GDANA#U0,
		mounted		R5F101GEANA#U0, R5F101GFANA#U0, R5F101GGANA#U0,
				R5F101GHANA#U0, R5F101GJANA#U0, R5F101GKANA#U0,
				R5F101GLANA#U0
				R5F101GAANA#W0, R5F101GCANA#W0,
				R5F101GDANA#W0, R5F101GEANA#W0,
				R5F101GFANA#W0, R5F101GGANA#W0,
				R5F101GHANA#W0, R5F101GJANA#W0,
			D	R5F101GKANA#W0, R5F101GLANA#W0
			D	R5F101GADNA#U0, R5F101GCDNA#U0, R5F101GDDNA#U0, R5F101GEDNA#U0, R5F101GFDNA#U0, R5F101GGDNA#U0,
				R5F101GEDNA#00, R5F101GEDNA#00, R5F101GGDNA#00, R5F101GHDNA#U0, R5F101GJDNA#U0, R5F101GKDNA#U0,
				R5F101GLDNA#U0
				R5F101GADNA#W0, R5F101GCDNA#W0,
				R5F101GDDNA#W0, R5F101GEDNA#W0,
				R5F101GFDNA#W0, R5F101GGDNA#W0,
				R5F101GHDNA#W0, R5F101GJDNA#W0,
				R5F101GKDNA#W0, R5F101GLDNA#W0

Note For the fields of application, refer to Figure 1-1 Part Number, Memory Size, and Package of RL78/G13.

Caution The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.



#### Table 1-1. List of Ordering Part Numbers

				(10/12)
Pin count	Package	Data flash	Fields of Application	Ordering Part Number
80 pins	80-pin plastic LQFP (14 × 14 mm, 0.65 mm pitch)	Mounted	A	R5F100MFAFA#V0, R5F100MGAFA#V0, R5F100MHAFA#V0, R5F100MJAFA#V0, R5F100MKAFA#V0, R5F100MLAFA#V0 R5F100MFAFA#X0, R5F100MGAFA#X0, R5F100MHAFA#X0, R5F100MJAFA#X0, R5F100MKAFA#X0, R5F100MLAFA#X0 R5F100MFDFA#V0, R5F100MGDFA#V0, R5F100MHDFA#V0,
				R5F100MJDFA#V0, R5F100MKDFA#V0, R5F100MLDFA#V0 R5F100MFDFA#X0, R5F100MGDFA#X0, R5F100MHDFA#X0, R5F100MJDFA#X0, R5F100MKDFA#X0, R5F100MLDFA#X0
			G	R5F100MFGFA#V0, R5F100MGGFA#V0, R5F100MHGFA#V0, R5F100MJGFA#V0 R5F100MFGFA#X0, R5F100MGGFA#X0, R5F100MHGFA#X0, R5F100MJGFA#X0
		Not mounted	A	R5F101MFAFA#V0, R5F101MGAFA#V0, R5F101MHAFA#V0, R5F101MJAFA#V0, R5F101MKAFA#V0, R5F101MLAFA#V0 R5F101MFAFA#X0, R5F101MGAFA#X0, R5F101MHAFA#X0, R5F101MJAFA#X0, R5F101MKAFA#X0, R5F101MLAFA#X0
			D	R5F101MFDFA#V0, R5F101MGDFA#V0, R5F101MHDFA#V0, R5F101MJDFA#V0, R5F101MKDFA#V0, R5F101MLDFA#V0 R5F101MFDFA#X0, R5F101MGDFA#X0, R5F101MHDFA#X0, R5F101MJDFA#X0, R5F101MKDFA#X0, R5F101MLDFA#X0
	80-pin plastic LFQFP (12 × 12 mm, 0.5 mm pitch)	Mounted	A	R5F100MFAFB#V0, R5F100MGAFB#V0, R5F100MHAFB#V0, R5F100MJAFB#V0, R5F100MKAFB#V0, R5F100MLAFB#V0 R5F100MFAFB#X0, R5F100MGAFB#X0, R5F100MHAFB#X0, R5F100MJAFB#X0, R5F100MKAFB#X0, R5F100MLAFB#X0
			D	R5F100MFDFB#V0, R5F100MGDFB#V0, R5F100MHDFB#V0, R5F100MJDFB#V0, R5F100MKDFB#V0, R5F100MLDFB#V0 R5F100MFDFB#X0, R5F100MGDFB#X0, R5F100MHDFB#X0, R5F100MJDFB#X0, R5F100MKDFB#X0, R5F100MLDFB#X0
			G	R5F100MFGFB#V0, R5F100MGGFB#V0, R5F100MHGFB#V0, R5F100MJGFB#V0 R5F100MFGFB#X0, R5F100MGGFB#X0, R5F100MHGFB#X0, R5F100MJGFB#X0
		Not mounted	A	R5F101MFAFB#V0, R5F101MGAFB#V0, R5F101MHAFB#V0, R5F101MJAFB#V0, R5F101MKAFB#V0, R5F101MLAFB#V0 R5F101MFAFB#X0, R5F101MGAFB#X0, R5F101MHAFB#X0, R5F101MJAFB#X0, R5F101MKAFB#X0, R5F101MLAFB#X0
			D	R5F101MFDFB#V0, R5F101MGDFB#V0, R5F101MHDFB#V0, R5F101MJDFB#V0, R5F101MKDFB#V0, R5F101MLDFB#V0 R5F101MFDFB#X0, R5F101MGDFB#X0, R5F101MHDFB#X0, R5F101MJDFB#X0, R5F101MKDFB#X0, R5F101MLDFB#X0

Note For the fields of application, refer to Figure 1-1 Part Number, Memory Size, and Package of RL78/G13.

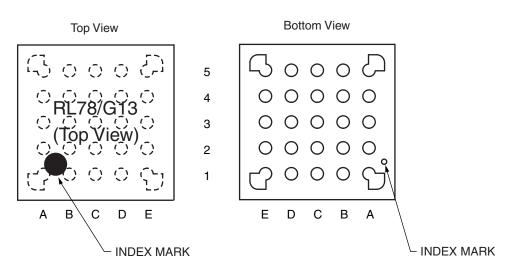
Caution The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.



## 1.3.3 25-pin products

• 25-pin plastic WFLGA (3 × 3 mm, 0.50 mm pitch)





	А	В	С	D	E	_
5	P40/TOOL0	RESET	P01/ANI16/ TO00/RxD1	P22/ANI2	P147/ANI18	5
4	P122/X2/ EXCLK	P137/INTP0	P00/ANI17/ TI00/TxD1	P21/ANI1/ AVrefm	P10/SCK00/ SCL00	4
3	P121/X1	Vdd	P20/ANI0/ AV <sub>REFP</sub>	P12/SO00/ TxD0/ TOOLTxD	P11/SI00/ RxD0/ TOOLRxD/ SDA00	3
2	REGC	Vss	P30/INTP3/ SCK11/SCL11	P17/Tl02/ TO02/SO11	P50/INTP1/ SI11/SDA11	2
1	P60/SCLA0	P61/SDAA0	P31/TI03/ TO03/INTP4/ PCLBUZ0	P16/TI01/ TO01/INTP5	P130	1
	А	В	С	D	E	

#### Caution Connect the REGC pin to Vss via a capacitor (0.47 to 1 $\mu$ F).

**Remark** For pin identification, see **1.4 Pin Identification**.



- **Notes 1.** Total current flowing into V<sub>DD</sub> and EV<sub>DD0</sub>, including the input leakage current flowing when the level of the input pin is fixed to V<sub>DD</sub>, EV<sub>DD0</sub> or V<sub>SS</sub>, EV<sub>SS0</sub>. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  - 2. During HALT instruction execution by flash memory.
  - 3. When high-speed on-chip oscillator and subsystem clock are stopped.
  - 4. When high-speed system clock and subsystem clock are stopped.
  - When high-speed on-chip oscillator and high-speed system clock are stopped. When RTCLPC = 1 and setting ultra-low current consumption (AMPHS1 = 1). The current flowing into the RTC is included. However, not including the current flowing into the 12-bit interval timer and watchdog timer.
  - 6. Not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
  - 7. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
    - HS (high-speed main) mode: 2.7 V  $\leq$  V\_{DD}  $\leq$  5.5 V@1 MHz to 32 MHz
      - 2.4 V  $\leq$  V\_{DD}  $\leq$  5.5 V@1 MHz to 16 MHz
    - LS (low-speed main) mode:  $1.8 \text{ V} \le V_{\text{DD}} \le 5.5 \text{ V} @ 1 \text{ MHz}$  to 8 MHz
    - LV (low-voltage main) mode: 1.6 V  $\leq$  V\_{DD}  $\leq$  5.5 V@1 MHz to 4 MHz
  - 8. Regarding the value for current to operate the subsystem clock in STOP mode, refer to that in HALT mode.
- Remarks 1. fmx: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  - 2. fin: High-speed on-chip oscillator clock frequency
  - **3.** fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
  - Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is T<sub>A</sub> = 25°C



- **Notes 1.** Total current flowing into Vbb, EVbbb, and EVbb1, including the input leakage current flowing when the level of the input pin is fixed to Vbb, EVbb0, and EVbb1, or Vss, EVsso, and EVss1. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  - 2. When high-speed on-chip oscillator and subsystem clock are stopped.
  - 3. When high-speed system clock and subsystem clock are stopped.
  - 4. When high-speed on-chip oscillator and high-speed system clock are stopped. When AMPHS1 = 1 (Ultra-low power consumption oscillation). However, not including the current flowing into the 12-bit interval timer and watchdog timer.
  - **5.** Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
    - HS (high-speed main) mode: 2.7 V  $\leq$  V\_{DD}  $\leq$  5.5 V@1 MHz to 32 MHz
      - 2.4 V  $\leq$  V<sub>DD</sub>  $\leq$  5.5 V@1 MHz to 16 MHz
    - LS (low-speed main) mode:  $~~1.8~V \leq V_{\text{DD}} \leq 5.5~V @\,1~\text{MHz}$  to 8 MHz
    - LV (low-voltage main) mode: 1.6 V  $\leq$  V\_DD  $\leq$  5.5 V@1 MHz to 4 MHz
- Remarks 1. fmx: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  - 2. fin: High-speed on-chip oscillator clock frequency
  - **3.** fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
  - 4. Except subsystem clock operation, temperature condition of the TYP. value is  $T_A = 25^{\circ}C$



Parameter	Symbol	Conditions	、 U	S (high-speed LS (low-speed main) Mode main) Mode		LV (low-voltage main) Mode		Unit	
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Data setup time (reception)	tsu:dat	$\label{eq:states} \begin{array}{l} 2.7 \ V \leq EV_{\text{DD0}} \leq 5.5 \ V, \\ C_{\text{b}} = 50 \ pF, \ R_{\text{b}} = 2.7 \ k\Omega \end{array}$	1/fмск + 85 <sub>Note2</sub>		1/fмск + 145 <sub>Note2</sub>		1/fмск + 145 <sub>Note2</sub>		ns
		$\label{eq:linear} \begin{split} 1.8 \ V &\leq EV_{\text{DD0}} \leq 5.5 \ V, \\ C_{\text{b}} &= 100 \ \text{pF}, \ R_{\text{b}} = 3 \ \text{k}\Omega \end{split}$	1/fмск + 145 <sub>Note2</sub>		1/fмск + 145 <sub>Note2</sub>		1/fмск + 145 <sub>Note2</sub>		ns
		$\label{eq:linear} \begin{split} 1.8 \ V &\leq EV_{\text{DD0}} < 2.7 \ V, \\ C_{\text{b}} &= 100 \ \text{pF}, \ R_{\text{b}} = 5 \ \text{k}\Omega \end{split}$	1/fмск + 230 <sub>Note2</sub>		1/f <sub>MCK</sub> + 230 <sub>Note2</sub>		1/fмск + 230 <sub>Note2</sub>		ns
		$\label{eq:linear} \begin{array}{l} 1.7 \mbox{ V} \leq EV_{\mbox{DD0}} < 1.8 \mbox{ V}, \\ C_{\mbox{b}} = 100 \mbox{ pF}, \mbox{ R}_{\mbox{b}} = 5 \mbox{ k}\Omega \end{array}$	1/fмск + 290 <sub>Note2</sub>		1/f <sub>MCK</sub> + 290 <sub>Note2</sub>		1/fмск + 290 <sub>Note2</sub>		ns
		$\label{eq:linear} \begin{array}{l} 1.6 \mbox{ V} \leq EV_{\mbox{DD0}} < 1.8 \mbox{ V}, \\ C_{\mbox{\tiny b}} = 100 \mbox{ pF}, \mbox{ R}_{\mbox{\tiny b}} = 5  k\Omega \end{array}$	—		1/f <sub>MCK</sub> + 290 <sub>Note2</sub>		1/fмск + 290 <sub>Note2</sub>		ns
Data hold time (transmission)	thd:dat	$\begin{array}{l} 2.7 \ \text{V} \leq \text{EV}_{\text{DD0}} \leq 5.5 \ \text{V}, \\ \text{C}_{\text{b}} = 50 \ \text{pF}, \ \text{R}_{\text{b}} = 2.7 \ \text{k}\Omega \end{array}$	0	305	0	305	0	305	ns
		$\label{eq:linear} \begin{array}{l} 1.8 \mbox{ V} \leq EV_{\mbox{DD0}} \leq 5.5 \mbox{ V}, \\ C_{\mbox{\tiny b}} = 100 \mbox{ pF}, \mbox{ R}_{\mbox{\tiny b}} = 3  k\Omega \end{array}$	0	355	0	355	0	355	ns
		$\label{eq:linear} \begin{array}{l} 1.8 \mbox{ V} \leq EV_{\mbox{DD0}} < 2.7 \mbox{ V}, \\ C_{\mbox{\tiny b}} = 100 \mbox{ pF}, \mbox{ R}_{\mbox{\tiny b}} = 5  k\Omega \end{array}$	0	405	0	405	0	405	ns
		$1.7 \text{ V} \leq \text{EV}_{\text{DD0}} < 1.8 \text{ V},$ $C_{\text{b}} = 100 \text{ pF}, \text{ R}_{\text{b}} = 5 \text{ k}\Omega$	0	405	0	405	0	405	ns
		$1.6 \text{ V} \leq \text{EV}_{\text{DD0}} < 1.8 \text{ V},$ $C_{\text{b}} = 100 \text{ pF}, \text{ R}_{\text{b}} = 5 \text{ k}\Omega$	_	_	0	405	0	405	ns

(5)	During communication at same potential (simplified I <sup>2</sup> C mode) (2/2)
	$(T_{A} = -40 \text{ to } +85^{\circ}\text{C}, 1.6 \text{ V} \le \text{EV}_{\text{DD0}} = \text{EV}_{\text{DD1}} \le \text{V}_{\text{DD}} \le 5.5 \text{ V}, \text{Vss} = \text{EV}_{\text{SS0}} = \text{EV}_{\text{SS1}} = 0 \text{ V})$

**Notes 1.** The value must also be equal to or less than  $f_{MCK}/4$ .

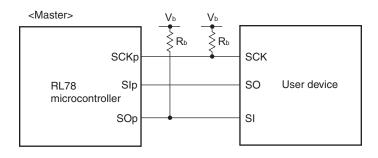
**2.** Set the fMCK value to keep the hold time of SCLr = "L" and SCLr = "H".

Caution Select the normal input buffer and the N-ch open drain output (VDD tolerance (When 20- to 52-pin products)/EVDD tolerance (When 64- to 128-pin products)) mode for the SDAr pin and the normal output mode for the SCLr pin by using port input mode register g (PIMg) and port output mode register h (POMh).

(**Remarks** are listed on the next page.)



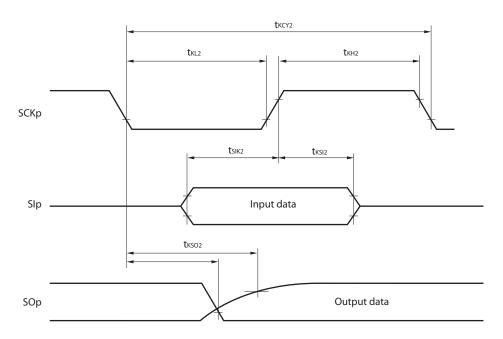
## CSI mode connection diagram (during communication at different potential)



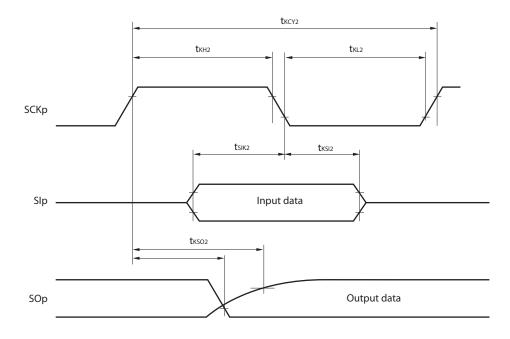
- **Remarks 1.** R<sub>b</sub>[Ω]:Communication line (SCKp, SOp) pull-up resistance, C<sub>b</sub>[F]: Communication line (SCKp, SOp) load capacitance, V<sub>b</sub>[V]: Communication line voltage
  - p: CSI number (p = 00, 01, 10, 20, 30, 31), m: Unit number, n: Channel number (mn = 00, 01, 02, 10, 12, 13), g: PIM and POM number (g = 0, 1, 4, 5, 8, 14)
  - **3.** fMCK: Serial array unit operation clock frequency (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).
    m: Unit number, n: Channel number (mn = 00))
  - **4.** CSI01 of 48-, 52-, 64-pin products, and CSI11 and CSI21 cannot communicate at different potential. Use other CSI for communication at different potential.



CSI mode serial transfer timing (slave mode) (during communication at different potential) (When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)



## CSI mode serial transfer timing (slave mode) (during communication at different potential) (When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.)



**Remarks 1.** p: CSI number (p = 00, 01, 10, 20, 30, 31), m: Unit number,

n: Channel number (mn = 00, 01, 02, 10, 12. 13), g: PIM and POM number (g = 0, 1, 4, 5, 8, 14)

**2.** CSI01 of 48-, 52-, 64-pin products, and CSI11 and CSI21 cannot communicate at different potential. Use other CSI for communication at different potential.



## 2.5.2 Serial interface IICA

## (1) $I^2C$ standard mode

## $(T_A = -40 \text{ to } +85^{\circ}C, 1.6 \text{ V} \le \text{EV}_{DD0} = \text{EV}_{DD1} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{ V}_{SS} = \text{EV}_{SS0} = \text{EV}_{SS1} = 0 \text{ V})$

Parameter	Symbol	Conditions			h-speed Mode		v-speed Mode			
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCLA0 clock frequency	fscl	Standard	$2.7~V \leq EV_{\text{DD0}} \leq 5.5~V$	0	100	0	100	0	100	kHz
		mode:	$1.8 \text{ V} \leq EV_{\text{DD0}} \leq 5.5 \text{ V}$	0	100	0	100	0	100	kHz
		fclk≥ 1 MHz	$1.7 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$	0	100	0	100	0	100	kHz
			$1.6 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$	_		0	100	0	100	kHz
Setup time of restart	tsu:sta	2.7 V ≤ EV <sub>DD0</sub> :	≤ 5.5 V	4.7		4.7		4.7		μs
condition		$1.8 V \le EV_{DD0}$	≤ 5.5 V	4.7		4.7		4.7		μs
		$1.7 V \le EV_{DD0}$	≤ 5.5 V	4.7		4.7		4.7		μs
		1.6 V ≤ EV <sub>DD0</sub> ≤	5.5 V	-	_	4.7		4.7		μs
Hold time <sup>Note 1</sup>	thd:sta	$2.7 \text{ V} \leq EV_{DD0}$	≤ 5.5 V	4.0		4.0		4.0		μs
		$1.8 V \le EV_{DD0}$	≤ 5.5 V	4.0		4.0		4.0		μs
		$1.7 \text{ V} \leq EV_{DD0}$	≤ 5.5 V	4.0		4.0		4.0		μs
		1.6 V ≤ EV <sub>DD0</sub> ≤	≤ 5.5 V	_	_	4.0		4.0		μs
Hold time when SCLA0 =	t∟ow	$2.7 \text{ V} \leq EV_{DD0}$	≤ 5.5 V	4.7		4.7		4.7		μs
"L"		$1.8 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$		4.7		4.7		4.7		μs
		$1.7~V \leq EV_{\text{DD0}} \leq 5.5~V$		4.7		4.7		4.7		μs
		1.6 V ≤ EV <sub>DD0</sub> ≤	≤ 5.5 V	-	_	4.7		4.7		μs
Hold time when SCLA0 =	tніgн	$2.7 V \le EV_{DD0}$	≤ 5.5 V	4.0		4.0		4.0		μs
"H"		$1.8 V \le EV_{DD0}$	≤ 5.5 V	4.0		4.0		4.0		μs
		$1.7 V \le EV_{DD0}$	≤ 5.5 V	4.0		4.0		4.0		μs
		1.6 V ≤ EV <sub>DD0</sub> ≤	≤5.5 V	-	_	4.0		4.0		μs
Data setup time	tsu:dat	$2.7 \text{ V} \leq EV_{DD0}$	≤ 5.5 V	250		250		250		ns
(reception)		$1.8 V \le EV_{DD0}$	≤ 5.5 V	250		250		250		ns
		$1.7 V \le EV_{DD0}$	≤ 5.5 V	250		250		250		ns
		$1.6 \text{ V} \leq \text{EV}_{\text{DD0}} \leq$	≤ 5.5 V	-		250		250		ns
Data hold time	thd:dat	$2.7 \text{ V} \leq EV_{DD0}$	≤ 5.5 V	0	3.45	0	3.45	0	3.45	μs
(transmission) <sup>Note 2</sup>		$1.8 V \le EV_{DD0}$	≤ 5.5 V	0	3.45	0	3.45	0	3.45	μs
		$1.7 V \le EV_{DD0}$	≤ 5.5 V	0	3.45	0	3.45	0	3.45	μs
		$1.6 \text{ V} \le \text{EV}_{\text{DD0}} \le$	≤ 5.5 V	-	_	0	3.45	0	3.45	μs
Setup time of stop	tsu:sto	$2.7 \text{ V} \leq EV_{\text{DD0}}$	≤ 5.5 V	4.0		4.0		4.0		μs
condition		$1.8 V \le EV_{DD0}$	≤ 5.5 V	4.0		4.0		4.0		μs
		$1.7 \text{ V} \leq EV_{DD0} \leq 5.5 \text{ V}$		4.0		4.0		4.0		μs
		$1.6 \text{ V} \leq \text{EV}_{\text{DD0}} \leq$	≤ 5.5 V	-		4.0		4.0		μs
Bus-free time	<b>t</b> BUF	$2.7 V \le EV_{DD0}$	≤ 5.5 V	4.7		4.7		4.7		μs
		$1.8 \text{ V} \leq EV_{\text{DD0}}$	≤ 5.5 V	4.7		4.7		4.7		μs
		$1.7 V \le EV_{DD0}$	≤ 5.5 V	4.7		4.7		4.7		μs
		1.6 V ≤ EV <sub>DD0</sub> ≤	≤ 5.5 V	-		4.7		4.7		μs

(Notes, Caution and Remark are listed on the next page.)



- **Notes 1.** Excludes quantization error ( $\pm 1/2$  LSB).
  - 2. This value is indicated as a ratio (%FSR) to the full-scale value.
  - $\label{eq:scalar} \begin{array}{l} \textbf{3. When } AV_{\text{REFP}} < V_{\text{DD}} \text{, the MAX. values are as follows.} \\ \text{Overall error: } Add \pm 1.0 \ \text{LSB} \ \text{to the MAX. value when } AV_{\text{REFP}} = V_{\text{DD}} \text{.} \\ \text{Zero-scale error/Full-scale error: } Add \pm 0.05\%\text{FSR} \ \text{to the MAX. value when } AV_{\text{REFP}} = V_{\text{DD}} \text{.} \\ \text{Integral linearity error/ Differential linearity error: } Add \pm 0.5 \ \text{LSB} \ \text{to the MAX. value when } AV_{\text{REFP}} = V_{\text{DD}} \text{.} \\ \end{array}$
  - 4. Values when the conversion time is set to 57  $\mu s$  (min.) and 95  $\mu s$  (max.).
  - 5. Refer to 2.6.2 Temperature sensor/internal reference voltage characteristics.



# 3. ELECTRICAL SPECIFICATIONS (G: INDUSTRIAL APPLICATIONS $T_A = -40$ to +105°C)

This chapter describes the following electrical specifications.

Target products G: Industrial applications  $T_A = -40$  to  $+105^{\circ}C$ R5F100xxGxx

- Cautions 1. The RL78 microcontrollers have an on-chip debug function, which is provided for development and evaluation. Do not use the on-chip debug function in products designated for mass production, because the guaranteed number of rewritable times of the flash memory may be exceeded when this function is used, and product reliability therefore cannot be guaranteed. Renesas Electronics is not liable for problems occurring when the on-chip debug function is used.
  - 2. With products not provided with an EVDD0, EVDD1, EVSS0, or EVSS1 pin, replace EVDD0 and EVDD1 with VDD, or replace EVSS0 and EVSS1 with VSS.
  - 3. The pins mounted depend on the product. Refer to 2.1 Port Function to 2.2.1 Functions for each product.
  - 4. Please contact Renesas Electronics sales office for derating of operation under  $T_A = +85^{\circ}C$  to +105°C. Derating is the systematic reduction of load for the sake of improved reliability.

**Remark** When RL78/G13 is used in the range of  $T_A = -40$  to +85°C, see **CHAPTER 2 ELECTRICAL SPECIFICATIONS (T<sub>A</sub> = -40 to +85°C)**.

There are following differences between the products "G: Industrial applications ( $T_A = -40$  to  $+105^{\circ}C$ )" and the products "A: Consumer applications, and D: Industrial applications".

Parameter	Ар	pplication
	A: Consumer applications, D: Industrial applications	G: Industrial applications
Operating ambient temperature	T <sub>A</sub> = -40 to +85°C	T <sub>A</sub> = -40 to +105°C
Operating mode Operating voltage range	$\begin{array}{l} \text{HS (high-speed main) mode:} \\ \text{2.7 V} \leq V_{\text{DD}} \leq 5.5 \ \text{V@1 MHz to 32 MHz} \\ \text{2.4 V} \leq V_{\text{DD}} \leq 5.5 \ \text{V@1 MHz to 16 MHz} \\ \text{LS (low-speed main) mode:} \\ \text{1.8 V} \leq V_{\text{DD}} \leq 5.5 \ \text{V@1 MHz to 8 MHz} \\ \text{LV (low-voltage main) mode:} \\ \text{1.6 V} \leq V_{\text{DD}} \leq 5.5 \ \text{V@1 MHz to 4 MHz} \end{array}$	HS (high-speed main) mode only: 2.7 V $\leq$ V <sub>DD</sub> $\leq$ 5.5 V@1 MHz to 32 MHz 2.4 V $\leq$ V <sub>DD</sub> $\leq$ 5.5 V@1 MHz to 16 MHz
High-speed on-chip oscillator clock accuracy	$\begin{array}{l} 1.8 \ V \leq V_{DD} \leq 5.5 \ V \\ \pm 1.0\% @ \ T_{A} = -20 \ to \ +85^{\circ}C \\ \pm 1.5\% @ \ T_{A} = -40 \ to \ -20^{\circ}C \\ 1.6 \ V \leq V_{DD} < 1.8 \ V \\ \pm 5.0\% @ \ T_{A} = -20 \ to \ +85^{\circ}C \\ \pm 5.5\% @ \ T_{A} = -40 \ to \ -20^{\circ}C \end{array}$	$\begin{array}{l} 2.4 \ V \leq V_{DD} \leq 5.5 \ V \\ \pm 2.0\% @ \ T_{A} = +85 \ to \ +105^{\circ}C \\ \pm 1.0\% @ \ T_{A} = -20 \ to \ +85^{\circ}C \\ \pm 1.5\% @ \ T_{A} = -40 \ to \ -20^{\circ}C \end{array}$
Serial array unit	UART CSI: fcLk/2 (supporting 16 Mbps), fcLk/4 Simplified I <sup>2</sup> C communication	UART CSI: fcLk/4 Simplified I <sup>2</sup> C communication
IICA	Normal mode Fast mode Fast mode plus	Normal mode Fast mode
Voltage detector	Rise detection voltage: 1.67 V to 4.06 V (14 levels) Fall detection voltage: 1.63 V to 3.98 V (14 levels)	Rise detection voltage: 2.61 V to 4.06 V (8 levels) Fall detection voltage: 2.55 V to 3.98 V (8 levels)

(Remark is listed on the next page.)



- **Notes 1.** Total current flowing into V<sub>DD</sub> and EV<sub>DD0</sub>, including the input leakage current flowing when the level of the input pin is fixed to V<sub>DD</sub>, EV<sub>DD0</sub> or Vss, EV<sub>SS0</sub>. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  - 2. During HALT instruction execution by flash memory.
  - 3. When high-speed on-chip oscillator and subsystem clock are stopped.
  - 4. When high-speed system clock and subsystem clock are stopped.
  - When high-speed on-chip oscillator and high-speed system clock are stopped. When RTCLPC = 1 and setting ultra-low current consumption (AMPHS1 = 1). The current flowing into the RTC is included. However, not including the current flowing into the 12-bit interval timer and watchdog timer.
  - 6. Not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
  - 7. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.

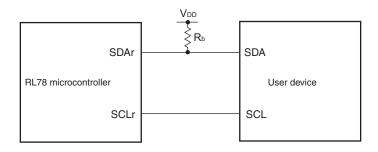
HS (high-speed main) mode:  $2.7 \text{ V} \le \text{V}_{\text{DD}} \le 5.5 \text{ V}@1 \text{ MHz}$  to 32 MHz

2.4 V 
$$\leq$$
 V<sub>DD</sub>  $\leq$  5.5 V@1 MHz to 16 MHz

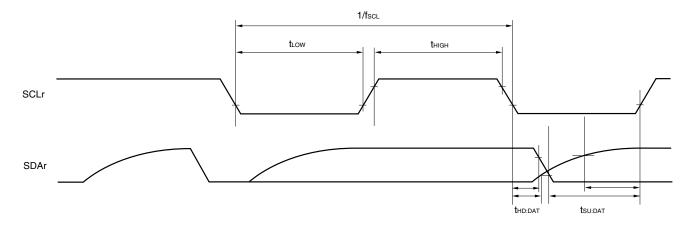
- 8. Regarding the value for current operate the subsystem clock in STOP mode, refer to that in HALT mode.
- **Remarks 1.** f<sub>MX</sub>: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  - 2. file: High-speed on-chip oscillator clock frequency
  - **3.** fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
  - 4. Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is  $T_{\text{A}}=25^{\circ}\text{C}$



#### Simplified I<sup>2</sup>C mode mode connection diagram (during communication at same potential)



## Simplified I<sup>2</sup>C mode serial transfer timing (during communication at same potential)



- **Remarks 1.** R<sub>b</sub>[Ω]:Communication line (SDAr) pull-up resistance, C<sub>b</sub>[F]: Communication line (SDAr, SCLr) load capacitance
  - r: IIC number (r = 00, 01, 10, 11, 20, 21, 30, 31), g: PIM number (g = 0, 1, 4, 5, 8, 14),
    h: POM number (g = 0, 1, 4, 5, 7 to 9, 14)
  - 3. fmck: Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number (m

= 0, 1), n: Channel number (n = 0 to 3), mn = 00 to 03, 10 to 13)



#### (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (1/2) ( $T_A = -40$ to $+105^{\circ}C$ , 2.4 V $\leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5$ V. Vss = $EV_{SS0} = EV_{SS1} = 0$ V)

Parameter	Symbol		Conditions		Conditions HS (high-speed main) Mode		-	Unit
					MIN.	MAX.		
Transfer rate		Reception	$4.0 \ V \ \leq \ EV_{\text{DD0}} \ \leq \ 5.5$			fмск/12 <sup>Note 1</sup>	bps	
			V, $2.7 \text{ V} \leq V_b \leq 4.0 \text{ V}$	Theoretical value of the maximum transfer rate fcLK = 32 MHz, fMCK = fcLK		2.6	Mbps	
	$\begin{array}{l} 2.7 \ V \leq EV_{\text{DD0}} < 4.0 \\ V, \\ 2.3 \ V \leq V_b \leq 2.7 \ V \end{array}$			fмск/12 <sup>Note 1</sup>	bps			
		Theoretical value of the maximum transfer rate fcLK = 32 MHz, fMCK = fcLK		2.6	Mbps			
		$2.4 V \leq EV_{DD0} < 3.3 V,$			fмск/12 Notes 1,2	bps		
			$1.6~V \leq V_b \leq 2.0~V$	Theoretical value of the maximum transfer rate fcLk = 32 MHz, fMck = fcLk		2.6	Mbps	

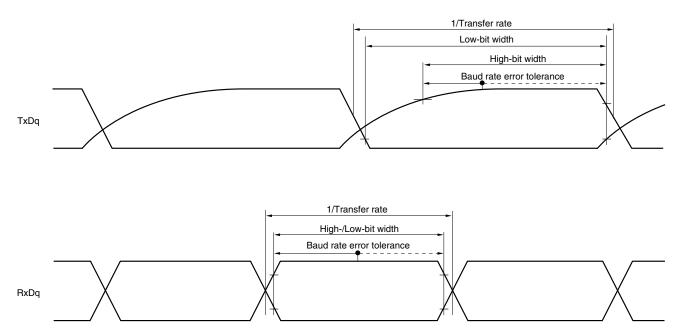
Notes 1. Transfer rate in the SNOOZE mode is 4800 bps only.

- 2. The following conditions are required for low voltage interface when  $E_{VDD0}$  <  $V_{DD}.$  2.4 V  $\leq$   $EV_{DD0}$  < 2.7 V : MAX. 1.3 Mbps
- Caution Select the TTL input buffer for the RxDq pin and the N-ch open drain output (VDD tolerance (for the 20- to 52-pin products)/EVDD tolerance (for the 64- to 100-pin products)) mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg). For VIH and VIL, see the DC characteristics with TTL input buffer selected.
- **Remarks 1.**  $V_{b}[V]$ : Communication line voltage
  - **2.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)
  - 3. fmck: Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13)

4. UART2 cannot communicate at different potential when bit 1 (PIOR1) of peripheral I/O redirection register (PIOR) is 1.





UART mode bit width (during communication at different potential) (reference)

 Remarks 1.
 Rb[Ω]:Communication line (TxDq) pull-up resistance,

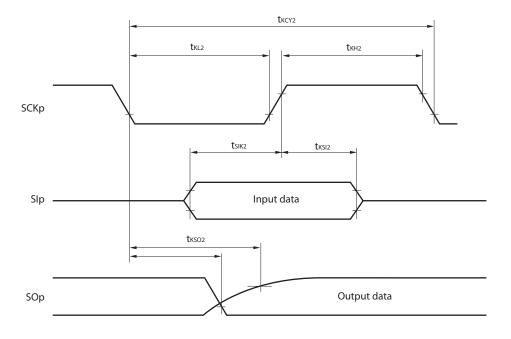
 Cb[F]: Communication line (TxDq) load capacitance, Vb[V]: Communication line voltage

- **2.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)
- 3. fmck: Serial array unit operation clock frequency

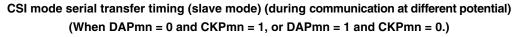
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

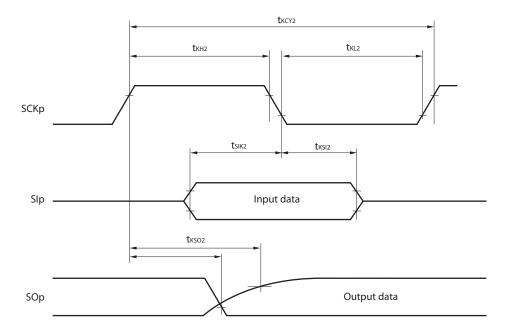
**4.** UART2 cannot communicate at different potential when bit 1 (PIOR1) of peripheral I/O redirection register (PIOR) is 1.





CSI mode serial transfer timing (slave mode) (during communication at different potential) (When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)





**Remarks 1.** p: CSI number (p = 00, 01, 10, 20, 30, 31), m: Unit number,

n: Channel number (mn = 00, 01, 02, 10, 12. 13), g: PIM and POM number (g = 0, 1, 4, 5, 8, 14)

**2.** CSI01 of 48-, 52-, 64-pin products, and CSI11 and CSI21 cannot communicate at different potential. Use other CSI for communication at different potential.

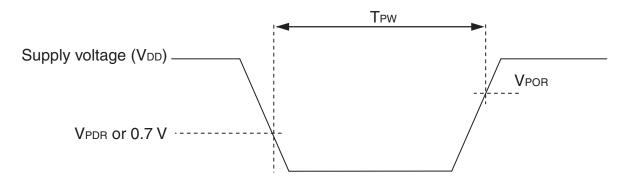


## 3.6.3 POR circuit characteristics

#### $(T_A = -40 \text{ to } +105^{\circ}\text{C}, \text{ Vss} = 0 \text{ V})$

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection voltage	VPOR	Power supply rise time	1.45	1.51	1.57	V
	VPDR	Power supply fall time	1.44	1.50	1.56	V
Minimum pulse width	TPW		300			μs

**Note** Minimum time required for a POR reset when V<sub>DD</sub> exceeds below V<sub>PDR</sub>. This is also the minimum time required for a POR reset from when V<sub>DD</sub> exceeds below 0.7 V to when V<sub>DD</sub> exceeds V<sub>POR</sub> while STOP mode is entered or the main system clock is stopped through setting bit 0 (HIOSTOP) and bit 7 (MSTOP) in the clock operation status control register (CSC).





3.6.5 Power supply voltage rising slope characteristics

#### $(T_A = -40 \text{ to } +105^{\circ}\text{C}, \text{Vss} = 0 \text{ V})$

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Power supply voltage rising slope	SVDD				54	V/ms

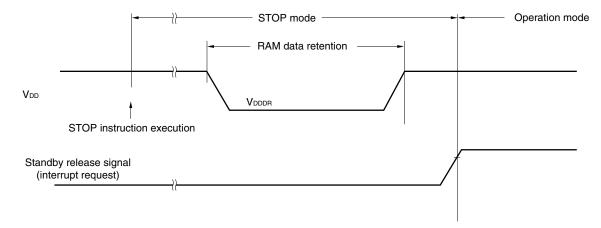
Caution Make sure to keep the internal reset state by the LVD circuit or an external reset until  $V_{DD}$  reaches the operating voltage range shown in 3.4 AC Characteristics.

#### 3.7 RAM Data Retention Characteristics

#### $(T_A = -40 \text{ to } +105^{\circ}\text{C}, \text{Vss} = 0 \text{ V})$

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Data retention supply voltage	VDDDR		1.44 <sup>Note</sup>		5.5	V

**Note** This depends on the POR detection voltage. For a falling voltage, data in RAM are retained until the voltage reaches the level that triggers a POR reset but not once it reaches the level at which a POR reset is generated.

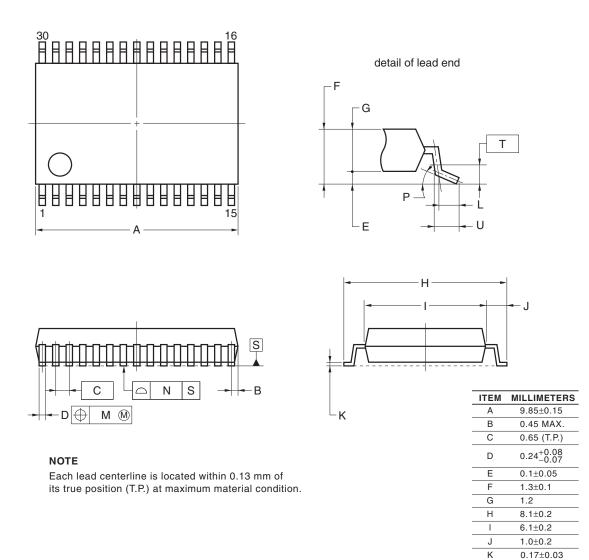




## 4.4 30-pin Products

R5F100AAASP, R5F100ACASP, R5F100ADASP, R5F100AEASP, R5F100AFASP, R5F100AGASP R5F101AAASP, R5F101ACASP, R5F101ADASP, R5F101AEASP, R5F101AFASP, R5F101AGASP R5F100AADSP, R5F100ACDSP, R5F100ADDSP, R5F100AEDSP, R5F100AFDSP, R5F100AGDSP R5F101AADSP, R5F101ACDSP, R5F101ADDSP, R5F101AEDSP, R5F101AFDSP, R5F101AGDSP R5F100AAGSP, R5F100ACGSP, R5F100ADGSP, R5F100AEGSP, R5F100AFGSP, R5F100AGGSP

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LSSOP30-0300-0.65	PLSP0030JB-B	S30MC-65-5A4-3	0.18





0.5

0.13

0.10 3°+5°

0.25

0.6±0.15

L

M N

P T

U

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